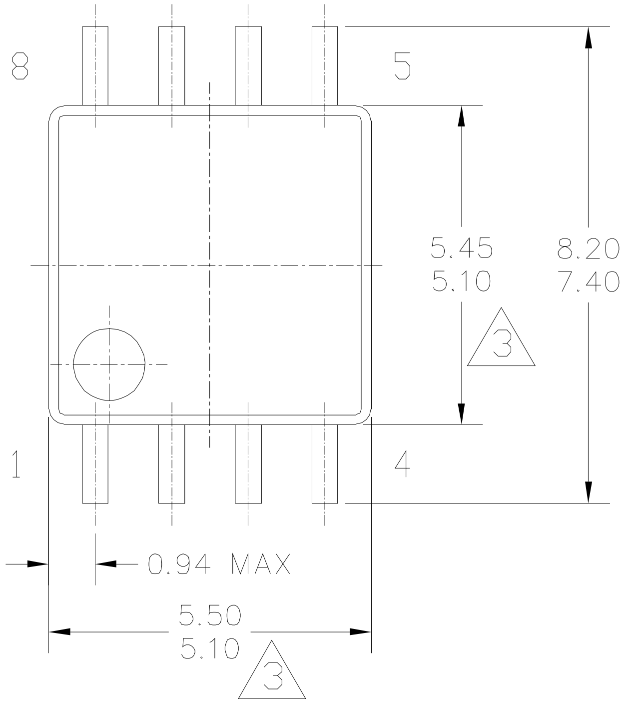

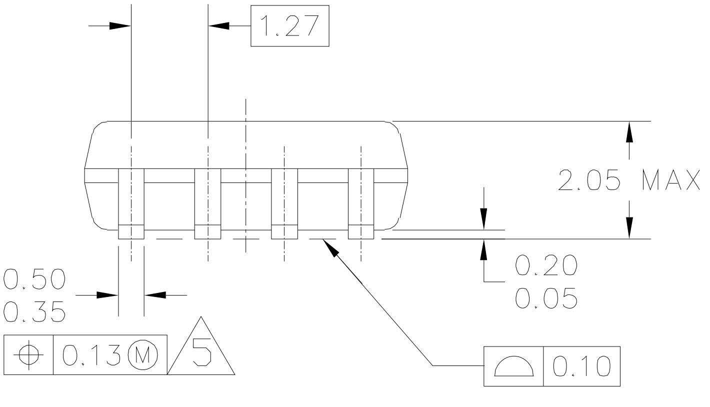

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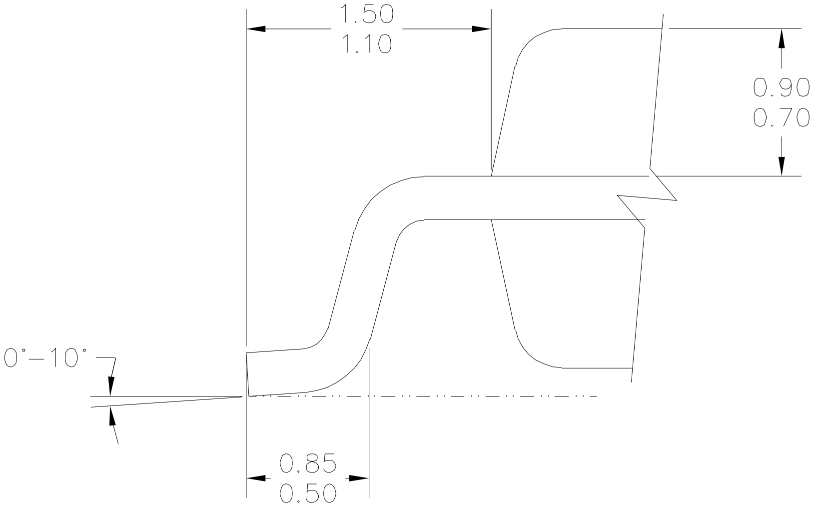
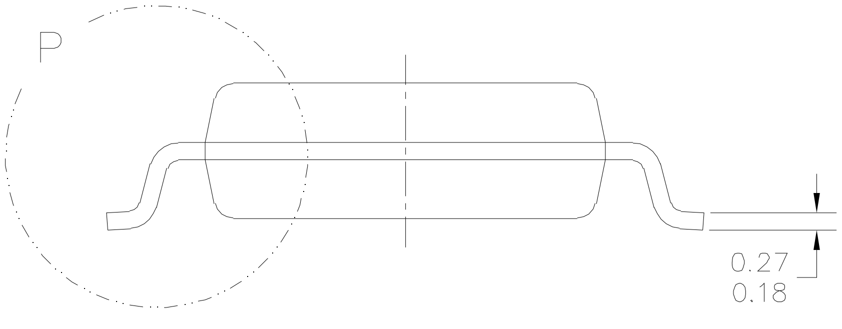
TITLE: 8 LEAD MFP	DOCUMENT NO: 98ASH70107A		REV: B
	CASE NUMBER: 968-01		19 MAY 2005
	STANDARD: EIAJ		



DETAIL P



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	CASE NUMBER: 968-01	19 MAY 2005
	STANDARD: EIAJ	

NOTES:

1. DIMENSIONS AND TOLERANCES PER ASME Y14.5−1994.

2. CONTROLLING DIMENSION: MILLIMETER.

3. DIMENSIONS DO NOT INCLUDE MOLD FLASH OR PROTRUSIONS AND ARE MEASURED AT THE PARTING LINE. MOLD FLASH OR PROTRUSIONS SHALL NOT EXCEDD 0.15mm PER SIDE.

4. TERMINAL NUMBERS ARE SHOWN FOR REFERENCE ONLY.

5. THE LEAD WIDTH DIMENSION DOES NOT INCLUDE DAMBAR PROTRUSION SHALL BE 0.08mm TOTAL IN EXCESS OF THE LEAD WIDTH DIMENSION AT MAXIMUM MATERIAL CONDITION. DAMBAR CANNOT BE LOCATED ON THE LOWER RADIUS OR THE FOOT. MINIMUM SPACE BETWEEN PROTRUSIONS AND ADJACENT LEAD TO BE 0.46mm.

MECHANICAL OUTLINE

PRINT VERSION NOT TO SCALE

TITLE:
8 LEAD MFP

DOCUMENT NO: 98ASH70107A

REV: B

CASE NUMBER: 968−01

19 MAY 2005

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